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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I ² C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	12
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 8x10b; D/A 1x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	14-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	14-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f1614-i-st

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

4.0 DEVICE CONFIGURATION

Device configuration consists of Configuration Words, Code Protection and Device ID.

4.1 Configuration Words

There are several Configuration Word bits that allow different oscillator and memory protection options. These are implemented as Configuration Word 1 at 8007h, Configuration Word 2 at 8008h, and Configuration 3 at 8009h.

Note:	The DEBUG bit in Configuration Words is
	managed automatically by device
	development tools including debuggers
	and programmers. For normal device
	operation, this bit should be maintained as
	a '1'.

8.0 POWER-DOWN MODE (SLEEP)

The Power-Down mode is entered by executing a SLEEP instruction.

Upon entering Sleep mode, the following conditions exist:

- 1. WDT will be cleared but keeps running, if enabled for operation during Sleep.
- 2. PD bit of the STATUS register is cleared.
- 3. $\overline{\text{TO}}$ bit of the STATUS register is set.
- 4. CPU clock is disabled.
- 5. 31 kHz LFINTOSC is unaffected and peripherals that operate from it may continue operation in Sleep.
- 6. Timer1 and peripherals that operate from Timer1 continue operation in Sleep when the Timer1 clock source selected is:
 - LFINTOSC
 - T1CKI
 - Timer1 oscillator
- 7. ADC is unaffected, if the dedicated FRC oscillator is selected.
- 8. I/O ports maintain the status they had before SLEEP was executed (driving high, low or highimpedance).
- 9. Resets other than WDT are not affected by Sleep mode.

Refer to individual chapters for more details on peripheral operation during Sleep.

To minimize current consumption, the following conditions should be considered:

- I/O pins should not be floating
- External circuitry sinking current from I/O pins
- Internal circuitry sourcing current from I/O pins
- Current draw from pins with internal weak pull-ups
- Modules using 31 kHz LFINTOSC
- CWG modules using HFINTOSC

I/O pins that are high-impedance inputs should be pulled to VDD or VSS externally to avoid switching currents caused by floating inputs.

Examples of internal circuitry that might be sourcing current include the FVR module. See **Section 15.0 "Fixed Voltage Reference (FVR)"** for more information on this module.

8.1 Wake-up from Sleep

The device can wake-up from Sleep through one of the following events:

- 1. External Reset input on MCLR pin, if enabled
- 2. BOR Reset, if enabled
- 3. POR Reset
- 4. Watchdog Timer, if enabled
- 5. Any external interrupt
- 6. Interrupts by peripherals capable of running during Sleep (see individual peripheral for more information)

The first three events will cause a device Reset. The last three events are considered a continuation of program execution. To determine whether a device Reset or wake-up event occurred, refer to **Section 6.12** "**Determining the Cause of a Reset**".

When the SLEEP instruction is being executed, the next instruction (PC + 1) is prefetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be enabled. Wake-up will occur regardless of the state of the GIE bit. If the GIE bit is disabled, the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is enabled, the device executes the instruction after the SLEEP instruction, the device will then call the Interrupt Service Routine. In cases where the execution of the instruction following SLEEP is not desirable, the user should have a NOP after the SLEEP instruction.

The WDT is cleared when the device wakes up from Sleep, regardless of the source of wake-up.

8.1.1 WAKE-UP USING INTERRUPTS

When global interrupts are disabled (GIE cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If the interrupt occurs **before** the execution of a SLEEP instruction
 - SLEEP instruction will execute as a NOP
 - WDT and WDT prescaler will not be cleared
 - TO bit of the STATUS register will not be set
 - PD bit of the STATUS register will not be cleared
- If the interrupt occurs **during or after** the execution of a SLEEP instruction
 - SLEEP instruction will be completely executed
 - Device will immediately wake-up from Sleep
 - WDT and WDT prescaler will be cleared
 - TO bit of the STATUS register will be set
 - PD bit of the STATUS register will be cleared

Even if the flag bits were checked before executing a SLEEP instruction, it may be possible for flag bits to become set before the SLEEP instruction completes. To determine whether a SLEEP instruction executed, test the PD bit. If the PD bit is set, the SLEEP instruction was executed as a NOP.



8.2 Low-Power Sleep Mode

This device contains an internal Low Dropout (LDO) voltage regulator, which allows the device I/O pins to operate at voltages up to 5.5V while the internal device logic operates at a lower voltage. The LDO and its associated reference circuitry must remain active when the device is in Sleep mode.

Low-Power Sleep mode allows the user to optimize the operating current in Sleep. Low-Power Sleep mode can be selected by setting the VREGPM bit of the VREGCON register, putting the LDO and reference circuitry in a low-power state whenever the device is in Sleep.

8.2.1 SLEEP CURRENT VS. WAKE-UP TIME

In the Default Operating mode, the LDO and reference circuitry remain in the normal configuration while in Sleep. The device is able to exit Sleep mode quickly since all circuits remain active. In Low-Power Sleep mode, when waking up from Sleep, an extra delay time is required for these circuits to return to the normal configuration and stabilize.

The Low-Power Sleep mode is beneficial for applications that stay in Sleep mode for long periods of time. The Normal mode is beneficial for applications that need to wake from Sleep quickly and frequently.

8.2.2 PERIPHERAL USAGE IN SLEEP

Some peripherals that can operate in Sleep mode will not operate properly with the Low-Power Sleep mode selected. The LDO will remain in the Normal-Power mode when those peripherals are enabled. The Low-Power Sleep mode is intended for use with these peripherals:

- Brown-Out Reset (BOR)
- Watchdog Timer (WDT)
- External interrupt pin/Interrupt-on-change pins
- Timer1 (with external clock source)

The Complementary Waveform Generator (CWG) can utilize the HFINTOSC oscillator as either a clock source or as an input source. Under certain conditions, when the HFINTOSC is selected for use with the CWG modules, the HFINTOSC will remain active during Sleep. This will have a direct effect on the Sleep mode current.

Please refer to sections **Section 28.11 "Operation During Sleep"** for more information.

The PIC16LF1614/8 does not have a con-Note: figurable Low-Power Sleep mode. PIC16LF1614/8 is an unregulated device and is always in the lowest power state when in Sleep, with no wake-up time penalty. This device has a lower maximum voltage VDD and I/O than the PIC16F1614/8. See Section 35.0 "Electrical Specifications" for more information.



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PIC16(L)F1614/8

10.6 Register Definitions: Flash Program Memory Control

REGISTER 10-1: PMDATL: PROGRAM MEMORY DATA LOW BYTE REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
			PMDA	T<7:0>			
bit 7							bit 0
Legend:							
R = Readable bit		W = Writable bit		U = Unimpleme	nted bit, read as '0	3	
u = Bit is unchanged		x = Bit is unknown		-n/n = Value at F	OR and BOR/Valu	ue at all other Res	sets
'1' = Bit is set		'0' = Bit is cleared					

bit 7-0

PMDAT<7:0>: Read/write value for Least Significant bits of program memory

REGISTER 10-2: PMDATH: PROGRAM MEMORY DATA HIGH BYTE REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—			PMDA	AT<13:8>		
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-6 Unimplemented: Read as '0'

bit 5-0 PMDAT<13:8>: Read/write value for Most Significant bits of program memory

REGISTER 10-3: PMADRL: PROGRAM MEMORY ADDRESS LOW BYTE REGISTER

| R/W-0/0 |
|---------|---------|---------|---------|---------|---------|---------|---------|
| | | | PMAD | R<7:0> | | | |
| bit 7 | | | | | | | bit 0 |

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **PMADR<7:0>**: Specifies the Least Significant bits for program memory address

REGISTER 10-4: PMADRH: PROGRAM MEMORY ADDRESS HIGH BYTE REGISTER

U-1	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
(1)				PMADR<14:8>	•		
bit 7							bit 0

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 Unimplemented: Read as '1'

bit 6-0 PMADR<14:8>: Specifies the Most Significant bits for program memory address

Note 1: Unimplemented, read as '1'.

17.1.5 INTERRUPTS

The ADC module allows for the ability to generate an interrupt upon completion of an Analog-to-Digital conversion. The ADC Interrupt Flag is the ADIF bit in the PIR1 register. The ADC Interrupt Enable is the ADIE bit in the PIE1 register. The ADIF bit must be cleared in software.

Note 1:	The ADIF bit is set at the completion of
	every conversion, regardless of whether
	or not the ADC interrupt is enabled.

2: The ADC operates during Sleep only when the FRC oscillator is selected.

This interrupt can be generated while the device is operating or while in Sleep. If the device is in Sleep, the interrupt will wake-up the device. Upon waking from Sleep, the next instruction following the SLEEP instruction is always executed. If the user is attempting to wake-up from Sleep and resume in-line code execution, the GIE and PEIE bits of the INTCON register must be disabled. If the GIE and PEIE bits of the INTCON register are enabled, execution will switch to the Interrupt Service Routine.

17.1.6 RESULT FORMATTING

The 10-bit ADC conversion result can be supplied in two formats, left justified or right justified. The ADFM bit of the ADCON1 register controls the output format.

Figure 17-3 shows the two output formats.

FIGURE 17-3: 10-BIT ADC CONVERSION RESULT FORMAT



21.1.3 SOFTWARE PROGRAMMABLE PRESCALER

A software programmable prescaler is available for exclusive use with Timer0. The prescaler is enabled by clearing the PSA bit of the OPTION_REG register.

Note:	The Watchdog Timer (WDT) uses its own
	independent prescaler.

There are eight prescaler options for the Timer0 module ranging from 1:2 to 1:256. The prescale values are selectable via the PS<2:0> bits of the OPTION_REG register. In order to have a 1:1 prescaler value for the Timer0 module, the prescaler must be disabled by setting the PSA bit of the OPTION_REG register.

The prescaler is not readable or writable. All instructions writing to the TMR0 register will clear the prescaler.

21.1.4 TIMER0 INTERRUPT

Timer0 will generate an interrupt when the TMR0 register overflows from FFh to 00h. The TMR0IF interrupt flag bit of the INTCON register is set every time the TMR0 register overflows, regardless of whether or not the Timer0 interrupt is enabled. The TMR0IF bit can only be cleared in software. The Timer0 interrupt enable is the TMR0IE bit of the INTCON register.

Note:	The Timer0 interrupt cannot wake the
	processor from Sleep since the timer is
	frozen during Sleep.

21.1.5 8-BIT COUNTER MODE SYNCHRONIZATION

When in 8-Bit Counter mode, the incrementing edge on the T0CKI pin must be synchronized to the instruction clock. Synchronization can be accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the instruction clock. The high and low periods of the external clocking source must meet the timing requirements as shown in **Section35.0** "**Electrical Specifications**".

21.1.6 OPERATION DURING SLEEP

Timer0 cannot operate while the processor is in Sleep mode. The contents of the TMR0 register will remain unchanged while the processor is in Sleep mode.

22.1 Timer1 Operation

The Timer1 module is a 16-bit incrementing counter which is accessed through the TMR1H:TMR1L register pair. Writes to TMR1H or TMR1L directly update the counter.

When used with an internal clock source, the module is a timer and increments on every instruction cycle. When used with an external clock source, the module can be used as either a timer or counter and increments on every selected edge of the external source.

Timer1 is enabled by configuring the TMR1ON and TMR1GE bits in the T1CON and T1GCON registers, respectively. Table 22-1 displays the Timer1 enable selections.

TABLE 22-1: TIMER1 ENABLE SELECTIONS

TMR10N	TMR1GE	Timer1 Operation
0	0	Off
0	1	Off
1	0	Always On
1	1	Count Enabled

22.2 Clock Source Selection

The TMR1CS<1:0> bits of the T1CON register are used to select the clock source for Timer1. Table 22-2 displays the clock source selections.

22.2.1 INTERNAL CLOCK SOURCE

When the internal clock source is selected, the TMR1H:TMR1L register pair will increment on multiples of Fosc as determined by the Timer1 prescaler.

When the Fosc internal clock source is selected, the Timer1 register value will increment by four counts every instruction clock cycle. Due to this condition, a 2 LSB error in resolution will occur when reading the Timer1 value. To utilize the full resolution of Timer1, an asynchronous input signal must be used to gate the Timer1 clock input.

The following asynchronous sources may be used:

- Asynchronous event on the T1G pin to Timer1 gate
- C1 or C2 comparator input to Timer1 gate

22.2.2 EXTERNAL CLOCK SOURCE

When the external clock source is selected, the Timer1 module may work as a timer or a counter.

When enabled to count, Timer1 is incremented on the rising edge of the external clock input T1CKI. The external clock source can be synchronized to the microcontroller system clock or it can run asynchronously.

Note: In Counter mode, a falling edge must be registered by the counter prior to the first incrementing rising edge after any one or more of the following conditions:
 •Timer1 enabled after POR

- •Write to TMR1H or TMR1L
- Timer1 is disabled
- •Timer1 is disabled (TMR1ON = 0) when T1CKI is high then Timer1 is enabled (TMR1ON=1) when T1CKI is low.

TABLE 22-2: CLOCK SOURCE SELECTIONS

TMR1CS<1:0>	Clock Source
11	LFINTOSC
10	External Clocking on T1CKI Pin
01	System Clock (Fosc)
00	Instruction Clock (Fosc/4)

23.5.7 EDGE-TRIGGERED HARDWARE LIMIT ONE-SHOT MODE

In Edge-Triggered Hardware Limit One-Shot modes the timer starts on the first external signal edge after the ON bit is set and resets on all subsequent edges. Only the first edge after the ON bit is set is needed to start the timer. The counter will resume counting automatically two clocks after all subsequent external Reset edges. Edge triggers are as follows:

- Rising edge start and Reset (MODE<4:0> = 01100)
- Falling edge start and Reset (MODE<4:0> = 01101)

The timer resets and clears the ON bit when the timer value matches the PRx period value. External signal edges will have no effect until after software sets the ON bit. Figure 23-10 illustrates the rising edge hardware limit one-shot operation.

When this mode is used in conjunction with the CCP then the first starting edge trigger, and all subsequent Reset edges, will activate the PWM drive. The PWM drive will deactivate when the timer matches the CCPRx pulse-width value and stay deactivated until the timer halts at the PRx period match unless an external signal edge resets the timer before the match occurs.





The operation of the EUSART module is controlled through three registers:

- Transmit Status and Control (TXxSTA)
- Receive Status and Control (RCxSTA)
- Baud Rate Control (BAUDxCON)

These registers are detailed in Register 25-1, Register 25-2 and Register 25-3, respectively.

The RX and CK input pins are selected with the RXPPS and CKPPS registers, respectively. TX, CK, and DT output pins are selected with each pin's RxyPPS register. Since the RX input is coupled with the DT output in Synchronous mode, it is the user's responsibility to select the same pin for both of these functions when operating in Synchronous mode. The EUSART control logic will control the data direction drivers automatically.

1160KL 25-12.	STACHKOROUS RECEPTION (MASTER MODE, SREA)	
RX/DT pin TX/CK pin (SCKP = 0)	bit 0 bit 1 bit 2 bit 3 bit 4 bit 5 bit 6 bit 7	
TX/CK pin (SCKP = 1) Write to bit SREN		
SREN bit		
CREN bit		'0'
RCIF bit (Interrupt) ————		
Read RCxREG		
Note: Timing dia	agram demonstrates Sync Master mode with bit SREN = 1 and bit BRGH = 0 .	

FIGURE 25-12: SYNCHRONOUS RECEPTION (MASTER MODE, SREN)

TABLE 25-8: SUMMARY OF REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER RECEPTION RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELA	_	—	_	ANSA4	_	ANSA2	ANSA1	ANSA0	152
ANSELB ⁽¹⁾	_	_	ANSB5	ANSB4	_	—	—	—	159
ANSELC	ANSC7 ⁽¹⁾	ANSC6 ⁽¹⁾	-		ANSC3	ANSC2	ANSC1	ANSC0	166
BAUD1CON	ABDOVF	RCIDL		SCKP	BRG16	—	WUE	ABDEN	323
CKPPS						CKPPS<4:0>			174, 172
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	97
PIE1	TMR1GIE	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	98
PIR1	TMR1GIF	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	103
RC1REG			EUS	ART Receiv	e Data Regis	ster			316*
RC1STA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	322
RXPPS	_	— — RXPPS<4:0>			174, 172				
RxyPPS	_	—	—		F	RxyPPS<4:0	>		172
SP1BRGL	BRG<7:0>			324*					
SP1BRGH	BRG<15:8>			324*					
TRISA	_	_	TRISA5	TRISA4	(2)	TRISA2	TRISA1	TRISA0	151
TRISB ⁽¹⁾	TRISB7	TRISB6	TRISB5	TRISB4		—	—	—	158
TRISC	TRISC7 ⁽¹⁾	TRISC6 ⁽¹⁾	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	165
TX1STA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	321

Legend: — = unimplemented location, read as '0'. Shaded cells are not used for synchronous master reception.

* Page provides register information.

Note 1: PIC16(L)F1618 only.

2: Unimplemented, read as '1'.

26.0 CAPTURE/COMPARE/PWM MODULES

The Capture/Compare/PWM module is a peripheral which allows the user to time and control different events, and to generate Pulse-Width Modulation (PWM) signals. In Capture mode, the peripheral allows the timing of the duration of an event. The Compare mode allows the user to trigger an external event when a predetermined amount of time has expired. The PWM mode can generate Pulse-Width Modulated signals of varying frequency and duty cycle.

This family of devices contains two standard Capture/ Compare/PWM modules (CCP1 and CCP2).

- Note 1: In devices with more than one CCP module, it is very important to pay close attention to the register names used. A number placed after the module acronym is used to distinguish between separate modules. For example, the CCP1CON and CCP2CON control the same operational aspects of two completely different CCP modules.
 - 2: Throughout this section, generic references to a CCP module in any of its operating modes may be interpreted as being equally applicable to CCPx module. Register names, module signals, I/O pins, and bit names may use the generic designator 'x' to indicate the use of a numeral to distinguish a particular module, when required.

26.1 Capture Mode

The Capture mode function described in this section is available and identical for all CCP modules.

Capture mode makes use of the 16-bit Timer1 resource. When an event occurs on the CCPx input, the 16-bit CCPRxH:CCPRxL register pair captures and stores the 16-bit value of the TMR1H:TMR1L register pair, respectively. An event is defined as one of the following and is configured by the MODE<3:0> bits of the CCPxCON register:

- · Every edge (rising or falling)
- · Every falling edge
- Every rising edge
- Every 4th rising edge
- Every 16th rising edge

The CCPx capture input signal is configured by the CTS bits of the CCPxCAP register with the following options:

- CCPx pin
- Comparator 1 output (C1_OUT_sync)
- Comparator 2 output (C2_OUT_sync)
- Interrupt-on-change interrupt trigger (IOC_interrupt)

When a capture is made, the Interrupt Request Flag bit CCPxIF of the PIRx register is set. The interrupt flag must be cleared in software. If another capture occurs before the value in the CCPRxH, CCPRxL register pair is read, the old captured value is overwritten by the new captured value.

Figure shows a simplified diagram of the capture operation.

26.1.1 CCP PIN CONFIGURATION

In Capture mode, select the interrupt source using the CTS bits of the CCPxCAP register. If the CCPx pin is chosen, it should be configured as an input by setting the associated TRIS control bit.

26.4 CCP/PWM Clock Selection

The PIC16(L)F1614/8 allows each individual CCP and PWM module to select the timer source that controls the module. Each module has an independent selection.

As there are up to three 8-bit timers with auto-reload (Timer2/4/6), PWM mode on the CCP and PWM modules can use any of these timers.

The CCPTMRS register is used to select which timer is used.

26.4.1 USING THE TMR2/4/6 WITH THE CCP MODULE

This device has a new version of the TMR2 module that has many new modes, which allow for greater customization and control of the PWM signals than older parts. Refer to **Section23.5 "Operation Examples"** for examples of PWM signal generation using the different modes of Timer2. The CCP operation requires that the timer used as the PWM time base has the Fosc/4 clock source selected.

26.4.2 PWM PERIOD

The PWM period is specified by the PR2/4/6 register of Timer2/4/6. The PWM period can be calculated using the formula of Equation 26-1.

EQUATION 26-1: PWM PERIOD

$$PWM Period = [(PR2) + 1] \bullet 4 \bullet Tosc \bullet$$

(TMR2 Prescale Value)

Note 1: Tosc = 1/Fosc

When TMR2/4/6 is equal to its respective PR2/4/6 register, the following three events occur on the next increment cycle:

- TMR2/4/6 is cleared
- The CCPx pin is set. (Exception: If the PWM duty cycle = 0%, the pin will not be set.)
- The PWM duty cycle is latched from the CCPRxH:CCPRxL pair into the internal 10-bit latch.

Note:	The Timer postscaler (see Figure) is not
	used in the determination of the PWM
	frequency.

26.4.3 PWM DUTY CYCLE

The PWM duty cycle is specified by writing a 10-bit value to two registers: the CCPRxH:CCPRxL register pair. Where the particular bits go is determined by the FMT bit of the CCPxCON register. If FMT = 0, the two Most Significant bits of the duty cycle value should be written to bits <1:0> of CCPRxH register and the remaining eight bits to the CCPRxL register. If FMT = 1, the Least Significant two bits of the duty cycle should be written to bits <7:6> of the CCPRxL register and the Most Significant eight bits to the CCPRxH register. This is illustrated in Figure 26-4. These bits can be written at any time. The duty cycle value is not latched into the internal latch until after the period completes (i.e., a match between PR2/4/6 and TMR2/4/6 registers occurs).

Equation 26-2 is used to calculate the PWM pulse width. Equation 26-3 is used to calculate the PWM duty cycle ratio.

EQUATION 26-2: PULSE WIDTH

• (TMR2 Prescale Value)

EQUATION 26-3: DUTY CYCLE RATIO

Duty Cycle Ratio =
$$\frac{(CCPRxH:CCPRxL)}{4(PRx+1)}$$

The PWM duty cycle registers are double buffered for glitchless PWM operation.

The 8-bit timer TMR2/4/6 register is concatenated with either the 2-bit internal system clock (FOSC), or two bits of the prescaler, to create the 10-bit time base. The system clock is used if the Timer2/4/6 prescaler is set to 1:1.

When the 10-bit time base matches the internal buffer register, then the CCPx pin is cleared (see Figure).

FIGURE 26-4: CCPx DUTY-CYCLE ALIGNMENT



26.4.4 PWM RESOLUTION

The resolution determines the number of available duty cycles for a given period. For example, a 10-bit resolution will result in 1024 discrete duty cycles, whereas an 8-bit resolution will result in 256 discrete duty cycles.

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30.0 SIGNAL MEASUREMENT TIMER (SMT)

The SMT is a 24-bit counter with advanced clock and gating logic, which can be configured for measuring a variety of digital signal parameters such as pulse width, frequency and duty cycle, and the time difference between edges on two signals.

Features of the SMT include:

- 24-bit timer/counter
 - Four 8-bit registers (SMTxTMRL/H/U)
 - Readable and writable
 - Optional 16-bit operating mode
- Two 24-bit measurement capture registers
- One 24-bit period match register
- Multi-mode operation, including relative timing measurement
- Interrupt on period match
- Multiple clock, gate and signal sources
- Interrupt on acquisition complete
- · Ability to read current input values

Note: These devices implement two SMT modules. All references to SMTx apply to SMT1 and SMT2.

30.6.4 HIGH AND LOW MEASURE MODE

This mode measures the high and low pulse time of the SMTSIGx relative to the SMT clock. It begins incrementing the SMTxTMR on a rising edge on the SMTSIGx input, then updates the SMTxCPW register with the value and resets the SMTxTMR on a falling edge, starting to increment again. Upon observing another rising edge, it updates the SMTxCPR register with its current value and once again resets the SMTxTMR value and begins incrementing again. See Figure 30-8 and Figure 30-9.



FIGURE 30-9:

CALLW	Subroutine Call With W
Syntax:	[label] CALLW
Operands:	None
Operation:	$\begin{array}{l} (PC) +1 \rightarrow TOS, \\ (W) \rightarrow PC < 7:0>, \\ (PCLATH < 6:0>) \rightarrow PC < 14:8> \end{array}$
Status Affected:	None
Description:	Subroutine call with W. First, the return address (PC + 1) is pushed onto the return stack. Then, the contents of W is loaded into PC<7:0>, and the contents of PCLATH into PC<14:8>. CALLW is a 2-cycle instruction.

COMF	Complement f
Syntax:	[<i>label</i>] COMF f,d
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in [0,1] \end{array}$
Operation:	$(\overline{f}) \rightarrow (destination)$
Status Affected:	Z
Description:	The contents of register 'f' are com- plemented. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f'.

CLRF	Clear f
Syntax:	[label] CLRF f
Operands:	$0 \leq f \leq 127$
Operation:	$\begin{array}{l} 00h \rightarrow (f) \\ 1 \rightarrow Z \end{array}$
Status Affected:	Z
Description:	The contents of register 'f' are cleared and the Z bit is set.

Clear W

Syntax:	[label] CLRW
Operands:	None
Operation:	$\begin{array}{l} 00h \rightarrow (W) \\ 1 \rightarrow Z \end{array}$
Status Affected:	Z
Description:	W register is cleared. Zero bit (Z) is set.

CLRWDT	Clear Watchdog Timer
Syntax:	[label] CLRWDT
Operands:	None
Operation:	$00h \rightarrow WDT$ $0 \rightarrow WDT$ prescaler,

	$1 \rightarrow TO$
	$1 \rightarrow \overline{PD}$
Status Affected:	TO, PD
Description:	CLRWDT instruction resets the Watch- dog Timer. It also resets the prescaler of the WDT. Status bits TO and PD are set.

DECF	Decrement f
Syntax:	[label] DECF f,d
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in [0,1] \end{array}$
Operation:	(f) - 1 \rightarrow (destination)
Status Affected:	Z
Description:	Decrement register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in regis- ter 'f'.

DECFSZ	Decrement f, Skip if 0
Syntax:	[label] DECFSZ f,d
Operands:	$\begin{array}{l} 0\leq f\leq 127\\ d\in [0,1] \end{array}$
Operation:	(f) - 1 \rightarrow (destination); skip if result = 0
Status Affected:	None
Description:	The contents of register 'f' are decre- mented. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed back in register 'f'. If the result is '1', the next instruction is executed. If the result is '0', then a NOP is executed instead, making it a 2-cycle instruction.

Note: Unless otherwise noted, VIN = 5V, Fosc = 500 kHz, CIN = 0.1 μ F, TA = 25°C.



FIGURE 36-7: IDD Typical, EC Oscillator MP Mode, PIC16F1614/8 Only.



FIGURE 36-8: IDD Maximum, EC Oscillator MP Mode, PIC16F1614/8 Only.



FIGURE 36-9: IDD Typical, EC Oscillator HP Mode, PIC16LF1614/8 Only.



FIGURE 36-10: IDD Maximum, EC Oscillator HP Mode, PIC16LF1614/8 Only.



FIGURE 36-11: IDD Typical, EC Oscillator HP Mode, PIC16F1614/8 Only.



FIGURE 36-12: IDD Maximum, EC Oscillator HP Mode, PIC16F1614/8 Only.

16-Lead Plastic Quad Flat, No Lead Package (ML) - 4x4x0.9mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS			
Dimension Limits		MIN	NOM	MAX	
Number of Pins	Ν	16			
Pitch	е	0.65 BSC			
Overall Height	Α	0.80	0.90	1.00	
Standoff	A1	0.00	0.02	0.05	
Contact Thickness	A3	0.20 REF			
Overall Width	E	4.00 BSC			
Exposed Pad Width	E2	2.50	2.65	2.80	
Overall Length	D	4.00 BSC			
Exposed Pad Length	D2	2.50	2.65	2.80	
Contact Width	b	0.25	0.30	0.35	
Contact Length	L	0.30	0.40	0.50	
Contact-to-Exposed Pad	K	0.20	-	-	

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated

3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

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20-Lead Ultra Thin Plastic Quad Flat, No Lead Package (GZ) - 4x4x0.5 mm Body [UQFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS		
Dimension	Dimension Limits		NOM	MAX
Number of Terminals	N	20		
Pitch	е	0.50 BSC		
Overall Height	Α	0.45	0.50	0.55
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3	0.127 REF		
Overall Width	E	4.00 BSC		
Exposed Pad Width	E2	2.60	2.70	2.80
Overall Length	D	4.00 BSC		
Exposed Pad Length	D2	2.60	2.70	2.80
Terminal Width	b	0.20	0.25	0.30
Terminal Length	L	0.30	0.40	0.50
Terminal-to-Exposed-Pad	K	0.20	-	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated

3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

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